PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SUNGJUN PARK	08/11/2014
SEUNGJUNE YI	08/11/2014
YOUNGDAE LEE	08/11/2014
SUNGHOON JUNG	08/11/2014
JAEWOOK LEE	08/11/2014

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14378908

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NAME OF SUBMITTER:	KARA E CRESTWELL
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DATE SIGNED:	08/15/2014

Total Attachments: 2

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PATENT 502937760 REEL: 033548 FRAME: 0063

BIRCH, STEWART, KOLASCH & BIRCH, LLP

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ASSIGNMENT

Application No.	14/378,908	Filed _	August 14, 2014
Insert Name(s) of Inventor(s)	***(Given Name F	AMILY NAME (ALL CA	PS))***
of inventor(s)	WHEREAS, PARK, Sungjun; YI, and LEE, Jaewook (hereinafter desi useful improvements in:		ngdae; JUNG, Sunghoon ned) has (have) invented certain new and
Insert Title of Invention	METHOD AND APPARATUS F REPORT IN WIRELESS COMM		ANSMISSION OF BUFFER STATUS EM
	for which an application for Letters undersigned (except in the case of a p		tates of America has been executed by the
Insert Date	on August 11	, 2014	; and
of Signing of Application Insert Name of Assignee	ublic of Voyon		
Insert Address of Assignee	of 20 Yeouido-dong Yeongdeungpo-	-	
СНЕСК ВОХ	its heirs, successors, legal represent desirous of acquiring the entire right, Patent(s) that may be granted therefor in any foreign countries.	title and interest in and	ereinafter designated as the Assignee) is to said invention and in and to any Letters America and
paid, the recei undersigned he transfer unto s America, its te any and all L	paid, the receipt of which is hereby undersigned has (have) sold, assign transfer unto said Assignee the full America, its territories, dependencies any and all Letters Patent(s) which territories, dependencies and possess	acknowledged, and of ed and transferred, and and exclusive right to and possessions and may be granted ther	Pollars (\$10.00) to the undersigned in hand other good and valuable consideration, the d by these presents does sell, assign and the said invention in the United States of the entire right, title and interest in and to efor in the United States of America, its bove is designated, in any and all foreign
	and to any and all divisions, reissue term or terms for which the same may		ersions and extensions thereof for the full
continu	The undersigned agree(s) to execute ang, divisional, conversion or reissue ion with such applications as the Assignment	applications thereof an	a connection with this application and any d also to execute separate assignments in ry or expedient.

Page 1 of 2

and producing evidence and proceeding with such interference.

Industrial Property or similar agreements.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Aug. 11, 2014	Name of Inventor Sung Jun Park
_{Date} Aug. 11, 2014	(signature) PARK, Sungjun Seng June Y:
Date Aug. 11, 2014	(signature) YI, Seungjune Young Dee Gee
Date Aug. 11, 2014	(signature) LEE, Youngdae Suny Hoon Jung Zur Name of Inventor
Aug 11 2014	(signature) JUNG, Sunghoon Jae Wook Lee
Date 7449. 11, 2014,	Name of Inventor (signature) LEE, Jaewook

RECORDED: 08/15/2014